

Product & Process Change Notice (PCN)

PCN No: D110022

Date: 27-Oct-2011

1. Describe present process / product:

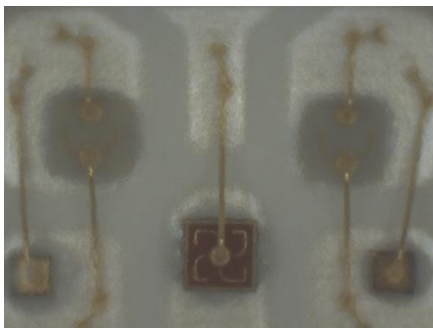
All devices in the family of D6RTB-DJD and D6RTB-HJD.

2. Product type affected:

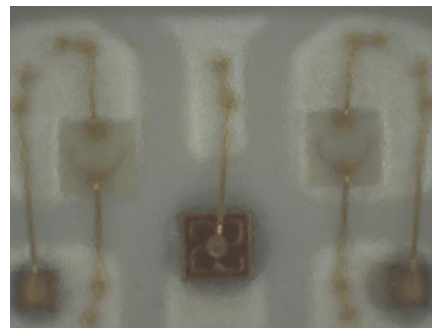
All devices in the family of D6RTB-DJD and D6RTB-HJD.

3. Describe changes (to be):

Propose to change the dark glue used for inter-connection between chip and lead-frame for the blue and true green chip to clear glue. All other material and product characteristics remain the same. The visual difference is very minimal as illustrated below.



Current



New

4. Reason for change:

The replacement of the dark glue to clear glue will improve the light extraction from the LED chips and improve the yield in manufacturing.

5. Target conversion date:

Evaluation sample is available upon request.

New material will be used for manufacturing beginning of Feb. 1st 2012.

Note : Any questions or requests for additional information should be directed to our Sales personnel